COVER LETTER

STMICROELECTRONICS SAS - STM32WB5MMGH

FCC ID: YCP-32WB5MMGH02

May 6, 2022

This report concerns: File : Modular Approval	
SubPart: SubPart 15C	
Equipment type : Chip enabling the user to communicate data through a Wireless interface	
Request issue of grant :	
⊠ Immediately upon completion of review	
Defer grant per 47 CFR 0.457(d)(1)(ii) until date Company Name agrees to notify the	
Commission bydate of the intended date of announcement of the product so that the grant	
can be issued on that date.	
Confidentiality of grant:	
Applicant requests the existence of this grant to be kept confidential untildate The announcement of this product before this date via freedom of information would be detrimental to Company	
Name, and therefore must be considered a business secret. Public announcement of this product will not	
be made prior to this date. (Max. 60 days after grant issued).	
Limits used: (check one)	
CISPR 22: Part15: _	\square
Measurement procedure used is ANSI C63.4-2014 / C63.10-2013 unless another is specified.	
Other standard managed and a	
Other test procedure :	
Application for verification	Applicant for this device
Prepared by :	/ Approxime and advise
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11/	Signature :
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Signature:	
Signature :	

*Not to be filed with Equipment Authorization Branch of FCC unless requested
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